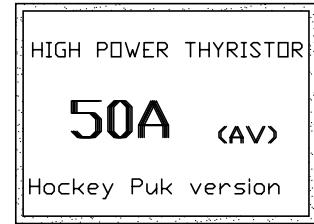
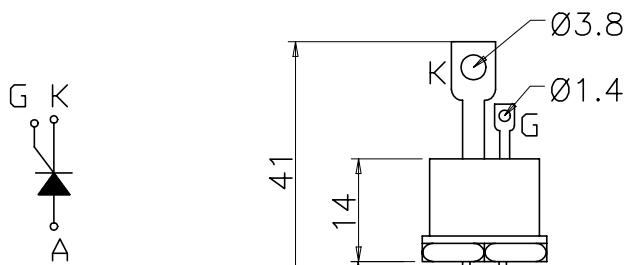


50RIA



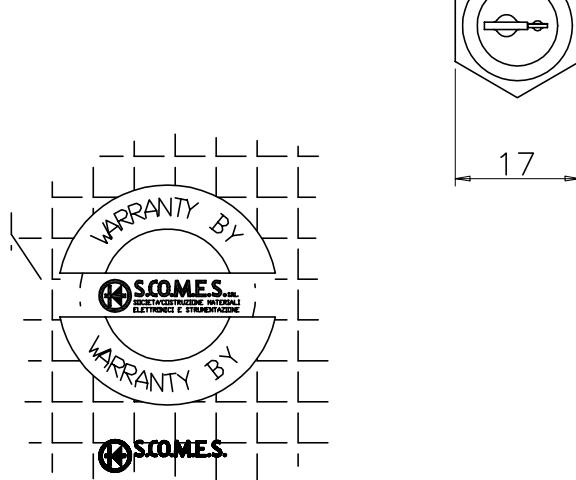
Features

- ④ High current rating
- ④ For general purpose application
- ④ Superior surge capabilities
- ④ Standard package
- ④ Metric thread version available



Ratings and Characteristics

Parameters	50RIA	Units
$I_{T(AV)}$	50	A
@ T_c MAX	94	A
$I_{T(RMS)}$	80	A
I_{TSM}	1200	A
@ 50Hz	1255	A
I^2t	7200	A^2s
@ 60Hz	6560	A^2s
I_{GT}	100	mA
V_{RRM}	50 to 1200	V
t_q typical	110	μs
T_j	-40 to 125	$^{\circ}C$



Voltage Ratings

Type number	Voltage Code	V_{RRM}/V_{DRM} max.repetitive peak reverse or off-state voltage V (2)	V_{RSM} maximum non- repetitive peak reverse voltage V (1)	I_{DM}/I_{RM} max. @ 125 $^{\circ}C$ mA
50RIA	40	400	500	15
	80	800	900	
	120	1200	1300	

ELECTRICAL SPECIFICATIONS

⑩ On-state Conduction

Parameter	50RIA	Units	Conditions
$I_{T(AV)}$ Max. average on-state current	50	A	180° sinusoidal conduction
$I_{T(RMS)}$ Max. RMS on-state current	80		
$I_{T(SM)}$ Max. peak,one-cycle non-repetitive surge current	1200 1255 1430 1490	A	50Hz half cycle sine wave or 6ms rectangular pulse 60Hz half cycle sine wave or 5ms rectangular pulse 50Hz half cycle sine wave or 6ms rectangular pulse 60Hz half cycle sine wave or 5ms rectangular pulse
I^2t Maximum I^2t for fusing	7200 6560 10180 9300	A^2s	t=10ms Rated V_{RRM} applied following surge t=8.3ms initial $T_J = 125^\circ C$ t=10ms V_{RRM} following surge=0,initial T=125°C t=8.3ms
$I^2\sqrt{t}$ Maximum $I^2\sqrt{t}$ for dev.fusing (3)	101.800	$A^2\sqrt{s}$	t=0.1to10ms V_{RRM} following surge=0,initial T=125°C
V_{TM} Max peak on-state voltage	1.6	V	$T_J = 25^\circ C$, $I_{T(AV)} = 50A(157A peak)$
I_H Max holding current	1.14	mA	$T_J = 25^\circ C$, anode supply=22V, initial $I_T = 2A$
I_L Max latching current	400	mA	Anode supply=6V, resistive load

⑩ Blocking

Parameter	50RIA	Units	Conditions
dv/dt Min.critical rate of rise of state voltage	200	$V/\mu s$	$T_J = 125^\circ C$.exponential to 100% rated V_{DRM} Zero gate bias voltage gate open circuited
	500	$V/\mu s$	$T_J = 125^\circ C$.exponential to 100% rated V_{DRM} Zero gate bias voltage gate open circuited

⑩ Switching

Parameter	50RIA	Units	Conditions
di/dt Max.non repetitive rate of rise of turned-on current $V_{RRM} = 50$ to 600V $V_{RRM} = 50$ to 600V	200 100	$A/\mu s$	$T_C = 25^\circ C$ V_{DM} =rated V_{DRM} , $I_{TM} = 10A$ dc resistive circuit, Gate pulse:10V,15ohm, tp=6 μs , tr=0.1 μs max.
t_d Typical delay time	1.0	μs	$T_C = 25^\circ C$ V_{DM} =rated V_{DRM} , $I_{TM} = 10A$ dc resistive circuit, Gate pulse:10V,15ohm source, tp=20 μs
t_q Typical turn-off time	110		$I_{TM} = 50A$, $T \geq 125^\circ C$, $di/dt = -10A/\mu s$, $V_R = 50V$ $dv/dt = 20V/\mu s$, Gate 0V 100 Ω

⑩ Triggering

Parameter	50RIA	Units	Conditions
P _{GM}	Maximum peak gate power	10.0	W
P _{G(AV)}	Maximum average gate power	2.5	W
I _{GM}	Max. peak positive gate current	2.5	A
+V _{GM}	Maximum peak positive gate voltage	20	V
-V _{GM}	Maximum peak negative gate voltage	10	
I _{GT}	DC gate current required to trigger	250 100 50	mA
V _{GT}	DC gate current required to trigger	3.5 2.5	V
I _{GD}	DC gate current not to trigger	5.0	mA
V _{GD}	DC gate voltage not to trigger	0.2	V

Notes:
 T_J = -40°C
 T_J = 25°C Max. required gate trigger/current
 T_J = 125°C rent/voltage are the lowest value which will trigger all units 6V anode-to-cathode applied
 T_J = -40°C which will trigger any unit with rated V_{DRM} anode-to-cathode applied
 Max. gate current/voltage not to trigger is the max. value which T_J = 125°C will not trigger any unit with rated V_{DRM} anode-to-cathode applied

⑪ Thermal and Mechanical Specification

Parameter	SCT180	Units	Conditions
T _J	Max.operating temperature range	-40 to 125	°C
T _{stg}	Max.storage temperature range	-40 to 125	
R _{th-C}	Max.thermal resistance, junction to case	0.35	deg.C/W DC
R _{thCS}	Max.thermal resistance, case to sink	0.25	deg.C/W Mounting surface smooth,flat and greased
T	Mounting torque	min. 2.8 (25) max. 3.4 (30)	N/m (lbf/in)
wt	Approximate weight	min. 28	gr.

- (1) For voltage pulses with tp < 5ms
- (2) Units may be broken over non repetitively in the off state direction without damage, if di/dt does not exceed 20A/μs
- (3) I²t for time tx=I²√t • √tx